

Termcenter 2800

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):

Wayne G. Renken

Title:

Process Condition Sensing Wafer and Data Analysis System

Application No.:

10/056,906

Filing Date:

January 24, 2002

Examiner:

Charles D. Garber

Group Art Unit:

2856

Docket No.:

SENS.005US0

Conf. No.:

2359

07/15/2004 SSESHE1 00000034 10056906

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

REQUEST FOR CONTINUED EXAMINATION (RCE)

Dear Sir:

This is a Request for Continued Examination (RCE) under 37 C.F.R. § 1.114 of the above-identified application.

Please consider the copy of an Amendment mailed on May 12, 2004 and the Information Disclosure Statement that is being filed herewith. The RCE fee required under 37 C.F.R. § 1.17(e) is paid in an accompanying check. An additional check is enclosed to extend the period for response to the Office Action dated January 12, 2004 by three months. This gives a period for response that ends on July 12, 2004.

The enclosed copy of the Amendment filed on May 12, 2004 includes a copy of a return-receipt postcard indicating that this amendment was received by the Patent Office. In addition, the attached printout of the file history of this case from the PAIR system indicates that an amendment in this case was received on May 17, 2004. However, in a phone discussion between Examiner Charles Garber and the undersigned attorney on July 9, 2004 it was indicated that this Amendment was not received by the Examiner and was therefore never

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considered. Therefore, this amendment is hereby resubmitted and its consideration is again requested. In addition, an IDS is submitted with one reference that was not previously cited in this case.

Please contact the undersigned attorney with any questions concerning this request or the above-identified patent application.

EXPRESS MAIL NO.:

EV437667836US

Respectfully submitted,

Peter A. Gallagher

Reg. No.47,584

Attorney Docket No.: SENS.005US0 Application No.: 10/056,906